

Data Sheet

Description

The SJPJ-D3 is a 30 V, 1.0 A Schottky diode with allowing improvements in V_F and I_R characteristics.

These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

Features

• V _{RSM}	30 V
KSM	
• I _{F(AV)}	1.0 A
• V _F (I _F = 1.0 A)	0.42 V typ.
A Dama Land Emanas Dh. fmaa (Dalle C	Tommliant)

• Bare Lead Frame: Pb-free (RoHS Compliant)

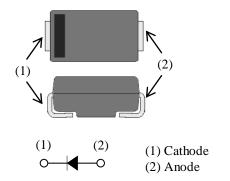
Applications

The high speed switching applications as follows:

- DC-DC Converter
- Adapter

Package

SJP



Not to scale

SJPJ-D3

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Rating	Unit	Conditions	
Peak Repetitive Reverse Voltage	V_{RSM}	30	V		
Repetitive Reverse Voltage	V_{RM}	30	V		
Average Forward Current	$I_{F(AV)}$	1.0	A	See Figure 1 and Figure 2	
Surge Forward Current	I_{FSM}	30	A	Half cycle sine wave, positive side, 10 ms, 1 shot	
I ² t Limiting Value	I ² t	4.5	A^2s	$1 \text{ ms} \le t \le 10 \text{ms}$	
Junction Temperature	T_{J}	-40 to 150	°C		
Storage Temperature	T_{STG}	-40 to 150	°C		

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	V_{F}	$I_F = 1.0 A$		0.42	0.45	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_		100	μΑ
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_		35	mA
Thermal Resistance ⁽¹⁾	R _{th(J-L)}				20	°C/W

 $^{^{(1)}\,}R_{\text{th (J-L)}}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves

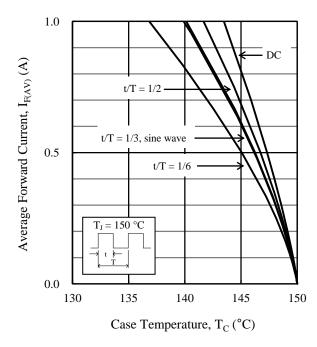


Figure 1. $T_C \, vs. \, I_{F(AV)} \, Typical \, Characteristics \ (V_R = 0 \, V)$

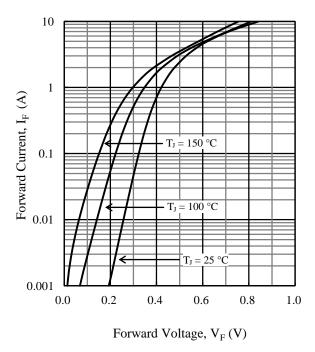


Figure 3. V_F vs. I_F Typical Characteristics

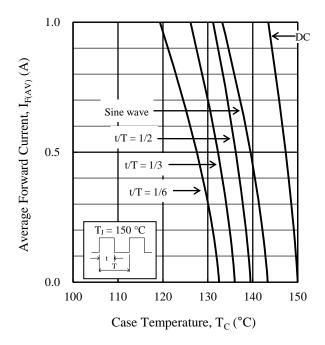


Figure 2. $T_C \, vs. \, I_{F(AV)} \, Typical \, Characteristics \ (V_R = 30 \, V)$

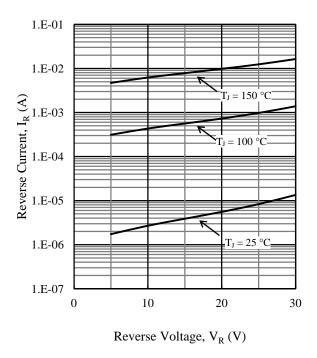
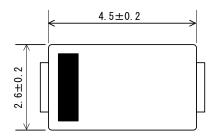
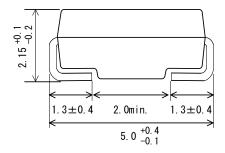


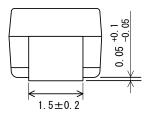
Figure 4. V_R vs. I_R Typical Characteristics

Physical Dimensions

• SJP Package







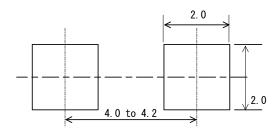
NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits: Flow: 260 \pm 5 °C / 10 \pm 1 s, 2 times

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time

- MSL: JEDEC LEVEL1

• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram

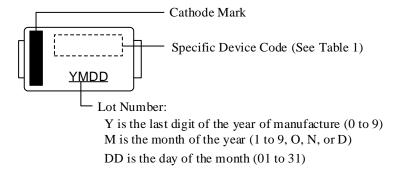


Table 1. Specific Device Code

Specific Device Code	Part Number
JD3	SJPJ-D3

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